LMH1251 Evaluation Board Users Guide v2.0

National Semiconductor Application Note 1836 Mike Stout June 24, 2008



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1.0 Introduction

The LMH1251 Evaluation Board is designed for bench evaluation and characterization of the LMH1251 device.

- A VGA 15-pin D-sub PC video connector and YP_BP_R RCA component Video connector are installed on the board for video source inputs 1 and 2, respectively.
- JP1, JP2, JP3, and JP4 are used to set the logic selection pins 21 through 24, by installing the jumpers in the appropriate configuration.

Since the LMH1251 is not intended to directly drive a video cable, a LMH6739 op amp with a gain of 2 is included on the board so that the output of the LMH1251 can be displayed on a monitor for visual inspection. Logic inverters are also included at the outputs of the H and V Sync outputs to provide output drive for the signals over the VGA cable. Typically, the LMH1251 is designed into a system board with extremely minimal trace length, AC coupled to the next stage, which can be either an ADC (TFT LCD monitor), or a preamplifier (CRT monitor).

The LMH1251 Evaluation Board has test point pads right at the RGB, H and V Sync outputs of the LMH1251 for oscilloscope probing (TP4, TP5, TP6, TP11, and TP12). Minimal length test leads can be soldered on these pads for probing with a low capacitance (<1 pF) FET probe such as the Tektronix P6245 for AC transient response measurements. DC level measurements can be taken with a passive probe such as the Tektronix P5050, 10 M Ω probe.

2.0 Board Electrical Specifications

Power Requirements:

 $V_{CC} = +6.0 \pm 0.1 V$, (at least 300 mA)

Analog Video Input:

0.7 V_{PP} RGB or $YP_{B}P_{R}$ (1.0 V_{PP} including sync.)

- PROGRESSIVE SCAN DVD Players
- 480i, 480p, 576i, 576p, 720p, 1080i, 1080p/60 video sources
- VGA UXGA VESA video sources

3.0 Jumper Instructions

- JP1: SD/HD Selection. (This should be left un-jumpered, when in Auto Mode, which is typically recommended.)
- JP2: Input Source Select
- JP3: Auto/Manual Mode Select
- JP4: Power Save Mode
- JP5: Horizontal Sync Output Polarity
- JP6: Vertical Sync Output Polarity
- Power Save Mode is enabled when "HIGH" and disabled when "LOW"
- Auto Mode is selected when JP3 is "HIGH", and Manual Mode is selected when JP3 is "LOW"
- Input Source 1 (PC/VGA) is selected when JP2 is "LOW", and Input Source 2 (YP_BP_R) is selected when JP2 is "HIGH"
- IF Manual Mode is selected, SD (480p) corresponds to JP1 being "LOW" and HD (720p and 1080i) corresponds to being "HIGH." IF Auto Mode is selected, JP1 must be left un-jumpered, and TP14 will measure "LOW" or "HIGH" depending on whether the input is SD or HD, respectively.





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6.0 Bill of Material

Used	Part Type	Designator	Footprint
1	+6V	J2	BANANA
1	.1 μF	C15	0805
6	.22 μF	C12, C13, C14, C23, C24, C25	0805
1	.0047 µF	C26	0805
2	0.1 µF	C29, C30	0603
2	0.1 µF	C4, C5	0805
8	1 GHZ PROBE	TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8	1 GHZ JACKX
1	1 GHZ PROBE	ТР9	1 GHZ JACKX
2	1K	R3, R4	0805
2	6.8 µF	C18, C21	TANT-A
1	6V/1A SKT	J1	POWER
1	10K	R30, R22, R23, R24	0805
1	10 µF	C2	TANT-B
6	33	R12, R16, R17, R18, R19, R21	0805
1	47 μF	C10	TANT-B
1	47 μH, DO1608	L1	DO1608
3	75	R14, R15, R43	0805
6	75	R5, R6, R13, R27, R28, R29	1206
7	100	R7, R8, R9, R20, R32, R33, R34	0805
2	100	R10, R11	1206
1	100 μF	C6	TANT-D
1	200	R31	0805
1	220 µF, AVX Low esr	C7	TANT-D
3	220 µF	C1, C3, C8	RCAP100
3	DIODE SCHOTTKY	D1, D2, D3	SOT-23 BAT54
1	DIODE SCHOTTKY	D4	DIODE 0.4
1	GND	J5	BANANA
2	HD DB15/3 ROWS	J3, J4	SUBMIN-15
2	HEADER 3	JP5, JP6	SIP3
1	LM1250	U2	24P TSSOP
1	LM2674–5.0	U4	SOP8
1	LM2937	U3	SOT-223
1	LMH6739	U5	SSOP16
2	R	R1, R2	0805
1	RCA JACK	J11	RCA TRIPLE
1	SN74AHC04	U1	TSSOP14
4	TEST POINT	TP11, TP12	TEST POINT

Notes

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